

Docket No.: INTEL-0021

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Confirmation No.: 7414

Edward A. BURTON, Kumar ANSHUMALI

Group Art Unit: 2818

Serial No: 10/607,550

Examiner: Nguyen, Dao H.

Filed: June 27, 2003

Customer No.: 34610

For: ADDITION OF METAL LAYERS WITH SIGNAL REALLOCATION TO A MICROPROCESSOR FOR INCREASED FREQUENCY AND LOWER POWER

U.S. Patent and Trademark Office
Customer Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

Dear Sir:

Transmitted herewith is an Amendment and/or Reply in the above identified application.

- ☐ No additional fee is required.
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	17	33	0	x \$50.00 =	
Independent Claims	1	3	0	x \$200.00=	
If multiple claims newly presented, add \$360.00					
Fee for extension of time					
TOTAL FEE DUE					\$ -0-

- ☐ Please charge my Deposit Account No. 16-0607 in the amount of \$____. An additional copy of this transmittal sheet is submitted herewith.
- ☐ A check in the amount of \$ _____ (Check # _____) is attached.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 16-0607, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Respectfully submitted,
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Intel Docket No: P15914 (2112-021)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of : Assignee: Intel Corporation

BURTON, E. et al. : Confirmation No. 7414

Serial No. 10/607,550 : Examiner: Nguyen, Dao H

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For: ADDITION OF METAL LAYERS WITH SIGNAL REALLOCATION TO A
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AMENDMENT

U.S. Patent and Trademark Office
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

June 30, 2006

Sir:

The following amendments and remarks are submitted in response to the Office
Action mailed on June 12, 2006, in connection with the above-identified application.

Amendments to the Claims are in the Listing of Claims beginning on page 2.

Remarks begin on page 6.